

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	09605293
<b>Filing Date:</b>	28-Jun-2000
<b>Title of Invention:</b>	SEMICONDUCTOR DEVICES INCLUDING A LAYER OF POLYCRYSTALLINE SILICON HAVING A SMOOTH MORPHOLOGY
<b>First Named Inventor/Applicant Name:</b>	DAVID L. CHAPEK
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<b>Attorney Docket Number:</b>	MI22-4201

Filed as Large Entity

### **Utility under 35 USC 111(a) Filing Fees**

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
<b>Post-Allowance-and-Post-Issuance:</b>				
Utility Appl issue fee	1501	1	1740	1740
Publ. Fee- early, voluntary, or normal	1504	1	300	300

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Extension-of-Time:</b>				
<b>Miscellaneous:</b>				
<b>Total in USD (\$)</b>				<b>2040</b>